Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<u>http://www.renesas.com</u>)

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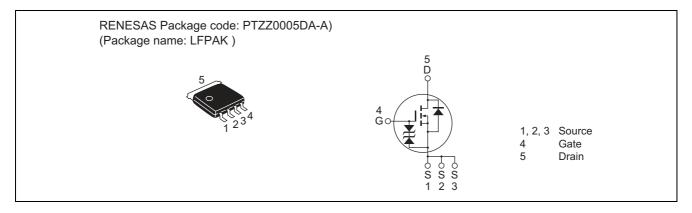
HAT2175H Silicon N Channel Power MOS FET Power Switching

REJ03G0006-0400 Rev.4.00 Sep 20, 2005

Features

- Capable of 8 V gate drive
- Low drive current
- High density mounting
- Low on-resistance $R_{DS(on)} = 33 \text{ m}\Omega \text{ typ.}$ (at $V_{GS} = 10 \text{ V}$)

Outline



Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	100	V
Gate to source voltage	V _{GSS}	± 20	V
Drain current	I _D	15	A
Drain peak current	I _{D(pulse)} Note1	60	A
Body-drain diode reverse drain current	I _{DR}	15	A
Avalanche current	I _{AP} Note 2	15	A
Avalanche energy	E _{AR} Note 2	22.5	mJ
Channel dissipation	Pch ^{Note3}	15	W
Channel to Case Thermal Resistance	θch-C	8.34	°C/W
Channel temperature	Tch	150	۵°
Storage temperature	Tstg	-55 to +150	٥C

Notes: 1. $PW \le 10 \propto s$, duty cycle $\le 1\%$

2. Value at Tch = 25°C, Rg \ge 50 Ω

3. Tc = $25^{\circ}C$



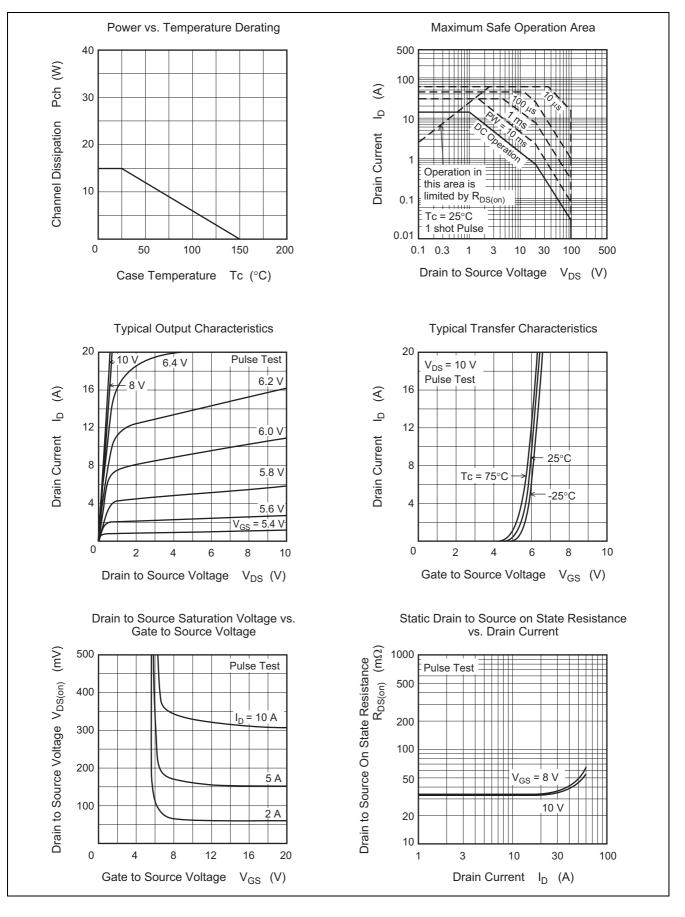
Electrical Characteristics

Symbol	Min	-			
		Тур	Max	Unit	Test Conditions
V _{(BR)DSS}	100			V	$I_D = 10 \text{ mA}, V_{GS} = 0$
$V_{(BR)GSS}$	± 20			V	$I_G = \pm 100 \propto A, \ V_{DS} = 0$
I _{GSS}			± 10	∝A	$V_{GS} = \pm 16 V, V_{DS} = 0$
I _{DSS}			1	∝A	$V_{DS} = 100 V, V_{GS} = 0$
V _{GS(off)}	4.0		6.0	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{mA}$
R _{DS(on)}	_	33	42	mΩ	$I_D = 7.5 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
R _{DS(on)}	_	34	46	mΩ	$I_D = 7.5 \text{ A}, V_{GS} = 8 \text{ V}^{Note4}$
y _{fs}	15	25	_	S	$I_D = 7.5 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$
Ciss	_	1445	_	pF	$V_{DS} = 10 V, V_{GS} = 0,$
Coss	_	185	_	pF	f = 1 MHz
Crss	_	61		pF	
Rg		0.55		Ω	
Qg		21		nC	$\label{eq:VDD} \begin{split} V_{\text{DD}} &= 50 \text{ V}, V_{\text{GS}} = 10 \text{ V}, \\ I_{\text{D}} &= 15 \text{ A} \end{split}$
Qgs		8		nC	
Qgd		4.5		nC	
t _{d(on)}		17		ns	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 7.5 \text{ A},$
tr		8.2		ns	
t _{d(off)}		28		ns	
t _f		4.7		ns	
V_{DF}	_	0.84	1.10	V	$IF = 15 A, V_{GS} = 0^{Note4}$
t _{rr}	_	45		ns	$IF = 15 A, V_{GS} = 0,$
					di _F / dt = 100 A/ μs
	V(BR)GSS IGSS IDSS VGS(off) RDS(on) RDS(on) Iyts Cisss Coss Crss Crss Crss Qg Qg Qg Qgs Qgd td(on) tr td(off) tf VDF	(LH, I) SOC Image: March and the second state in the second state	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

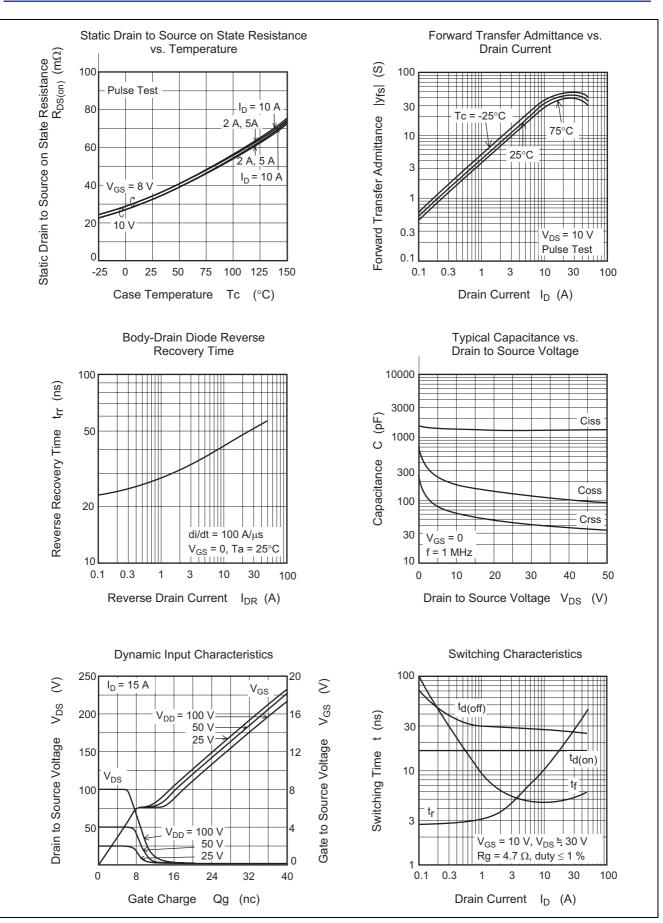
Notes: 4. Pulse test



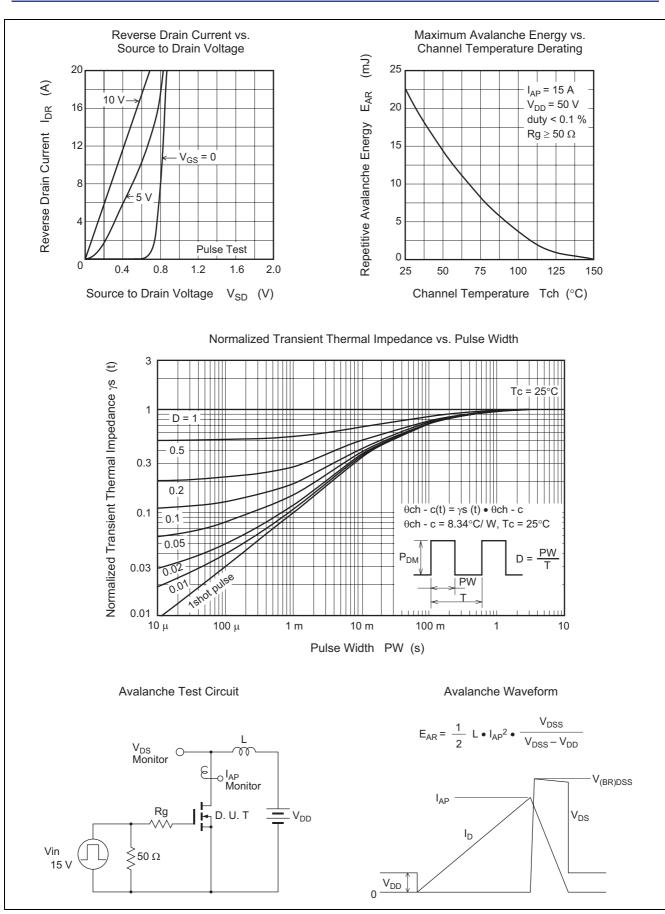
Main Characteristics



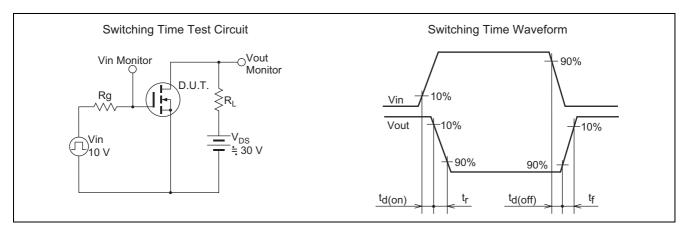






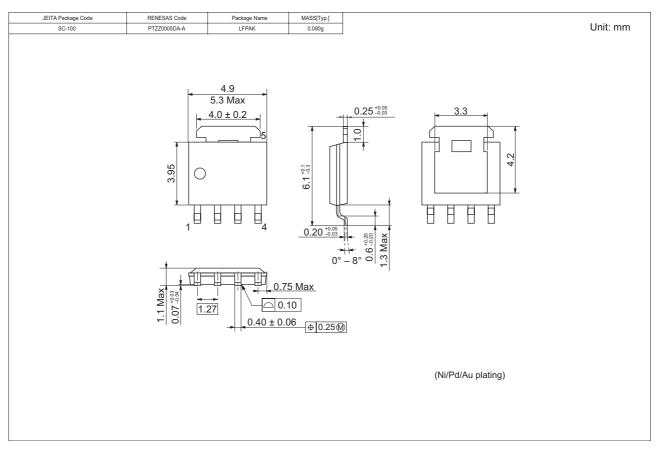








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2175H-EL-E	2500 pcs	Taping

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